Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1-3. (Cancelled)

4. (Currently Amended) A print assembly for pagewidth inkjet printing, the print assembly comprising

an elongate carrier that is mountable on a support structure of a printer in an operative position with respect to a platen of the printer;

a number of printhead chips including Micro Electrical Mechanical Systems (MEMS) incorporating actuator arms that are displaceable to eject inkpositioned on the carrier, the printhead chips each having a plurality of ink ejection nozzle arrangements on a wafer substrate, each nozzle arrangement having an actuator for ejecting ink from an associated nozzle when a resistive element of said actuator is heated by an electrical current supplied by drive circuitry on the wafer substrate positioned on the carrier and together defining a printhead that is configured to eject at least one billion drops per second into a printing zone defined between the printhead and the platen of the printer, the printhead chips being each positioned at a common angle of greater than zero degrees and less than ninety degrees with respect to a line extending a length of the printing zone, so that consecutive printhead chips overlap at their ends; and

control circuitry at least one controller that is also positioned on the carrier and that is configured to control operation of at least 10,000 nozzle arrangements of the printhead chips; and

a feed mechanism positioned on the support structure for feeding a print medium though the printing zone, the feed mechanism including a media roll for carrying print media to be provided to the printing zone and a take up spool configured to receive printed print media from the printing zone.

- (Cancelled)
- 6. (Cancelled)

- 7. (Currently Amended) A print assembly as claimed in claim 6claim 4, in which the printhead chips together incorporate at least one hundred thousand nozzle arrangements.
- 8. (Currently Amended) A print assembly as claimed in elaim 7claim 4, in which the printhead chips together incorporate at least two hundred thousand nozzle arrangements.
- 9. (Original) A print assembly as claimed in claim 8, which includes between forty and one hundred printhead chips positioned on the carrier.
- 10. (Original) A print assembly as claimed in claim 4, in which each printhead chip is the product of an integrated circuit fabrication process.
- 11. (Currently Amended) A print assembly as claimed in claim 10, in which each printhead chip includes a wafer substrate and and the drive circuitry is comprised in a CMOS drive circuitry layer positioned on the wafer substrate with the nozzle arrangements positioned on the wafer substrate and the CMOS drive circuitry layer.
- 12. (Previously Presented) A print assembly as claimed in claim 11, in which each nozzle arrangement is electrically connected to the CMOS drive circuitry layer.
- 13. (Original) A print assembly as claimed in claim 12, which includes a plurality of printhead modules, each printhead module incorporating a printhead chip, the printhead modules being mounted on the carrier.

14-20. (Cancelled)